ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					terials and	ials and Mfg Information				
upplier Inform	ation				·										
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
onsemi											2023-	2023-06-08			
Contact Name		Title - Contact			I	Phone - Contact*				Emai	Email - Contact*				
Product-Env-Stewar	rds		Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com			
uthorized Represen	ntative*	Title - Representative			I	Phone - Representative*				Emai	Email - Representative*				
Product-Env-Stewar	rds	Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com				
Requester	Requester Item Number		Mfr Item Number M		Mfr Item Name		Effective Date	e Vers	on Manufacturing Site			Weight*	UOM	Unit Type	
		NCP3170BDR2G 3A SW		3A SWITCHING	3A SWITCHING REGULATOR		2023-06-08			PH1		80.97	mg	Each	
Ianufacturing I	Proccess Information	on		,				·					·	·	
Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 MS		SL Rating	Peak Process Body Temperat		ire Max Time at P	eak Tempe	rature Num	ber of Reflow Cyc	eles			
Matte Tin (Sn) - annealed		C	CU Alloy 3			260 C		30	sec	conds 3					
omments															
TTENTION: MSL	3 Rated item requires I	Bake and D	ry Pack (afte	r electrical test)											
or more informatio	n regarding material co	mposition <b>j</b>	please refer t	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier shave provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier is liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.16	mg	Supplier	Silicon (Si)	7440-21-3		2.16	mg
Die Attach	0.57	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.114	mg
			Supplier	Silver (Ag)	7440-22-4		0.456	mg
Lead Frame	30.1		Supplier	Silver (Ag)	7440-22-4		0.2408	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0301	mg
			Supplier	Iron (Fe)	7439-89-6		0.7826	mg
			Supplier	Copper (Cu)	7440-50-8		29.0465	mg
Mold Compound-Black	46.48			Epoxy resin	proprietary data		2.324	mg
			Supplier	Phenolic Resin	Proprietary Data		2.324	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.9296	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2324	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		40.67	mg
Plating	1.49	mg	Supplier	Tin (Sn)	7440-31-5		1.49	mg
Wire Bond - Cu	0.17	mg	Supplier	Copper (Cu)	7440-50-8		0.17	mg